



# **SPECIFICATION**

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL05B471KB5NCNC

Product : Multi-layer Ceramic Capacitor

Description : CAP, 470pF, 50V, ±10%, X7R, 0402

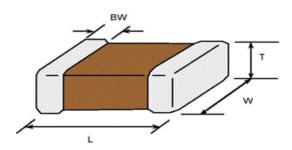
### A. Samsung Part Number

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1	Series	Samsung Multi-layer Ceramic Capacitor			
2	Size	0402 (inch code)	$L: 1.00 \pm 0.05 \text{ mm}$	$W:~0.50\pm0.05~\text{mm}$	
3	Dielectric	X7R	8 Inner elect	trode Ni	
4	Capacitance	470 pF	Terminatio	on Cu	
⑤	Capacitance	±10 %	Plating	Sn 100% (Pb Free)	
	tolerance		9 Product	High -Q	
6	Rated Voltage	50 V	Special	Reserved for future use	
7	Thickness	$0.50 \pm 0.05$ mm	① Packaging	Cardboard Type, 7" reel	

#### **B. Structure & Dimension**



Samsung P/N	Dimension(mm)				
Samsung F/N	L	W	Т	BW	
CL05B471KB5NCNC	1.00 ± 0.05	0.50 ± 0.05	0.50 ± 0.05	0.25 ± 0.10	

### C. Samsung Reliablility Test and Judgement Condition

CapacitanceWithin specified tolerance1 kHz ±10% / 1.0±0.2VrmsTan δ (DF)0.025 max.*A capacitor prior to measuring the capacitance is heat treated at 150 °C +0/-10 °C for 1hour and maintained in ambient air for 24±2 hours.Insulation10,000Mohm or 500Mohm×μFRated Voltage 60~120 sec.ResistanceWhichever is smallerAppearanceNo abnormal exterior appearanceMicroscope (×10)WithstandingNo dielectric breakdown or wechanical breakdown250% of the rated voltageVoltagemechanical breakdownTemperatureX7RCharacteristics(From-55 °C to 125 °C, Capacitance change should be within ±15%)Adhesive Strength of TerminationNo peeling shall be occur on the formination500g·f, for 10±1 sec.Bending StrengthCapacitance change: within ±12.5%Bending to the limit (1mm) with 1.0mm/sec.SolderabilityMore than 75% of terminal surfaceSnAg3.0Cu0.5 solder		Judgement	Test condition		
Tan δ (DF)0.025 max.treated at 150 °C +0/-10 °C for 1hour and maintained in ambient air for 24±2 hours.Insulation10,000Mohm or 500Mohm×μFRated Voltage60~120 sec.ResistanceWhichever is smallerMicroscope (×10)AppearanceNo abnormal exterior appearanceMicroscope (×10)WithstandingNo dielectric breakdown or mechanical breakdown250% of the rated voltageVoltageX7RX7RCharacteristics(From-55 °C to 125 °C, Capacitance change should be within ±15%)Adhesive Strength of TerminationNo peeling shall be occur on the terminal electrode500g·f, for 10±1 sec.Bending StrengthCapacitance change : within ±12.5%Bending to the limit (1mm) with 1.0mm/sec.	Capacitance	Within specified tolerance	1kHz ±10% / 1.0±0.2Vrms		
Resistance  Appearance  No abnormal exterior appearance  Microscope (×10)  Withstanding  No dielectric breakdown or  Voltage  Temperature  Characteristics  (From-55°C to 125°C, Capacitance change should be within ±15%)  Adhesive Strength  of Termination  Bending Strength  Capacitance change: within ±12.5%  Bending to the limit (1mm)  with 1.0mm/sec.		0.025 max.			
Appearance No abnormal exterior appearance Microscope (×10)  Withstanding No dielectric breakdown or wechanical breakdown  Temperature Characteristics (From-55°C to 125°C, Capacitance change should be within ±15%)  Adhesive Strength of Termination  Bending Strength Capacitance change: within ±12.5%  Bending to the limit (1mm) with 1.0mm/sec.	Insulation 10,000Mohm or 500Mohm×μF		Rated Voltage 60~120 sec.		
Withstanding       No dielectric breakdown or wechanical breakdown       250% of the rated voltage         Temperature       X7R         Characteristics       (From-55℃ to 125℃, Capacitance change should be within ±15%)         Adhesive Strength of Termination       No peeling shall be occur on the terminal electrode       500g·f, for 10±1 sec.         Bending Strength       Capacitance change : within ±12.5%       Bending to the limit (1mm) with 1.0mm/sec.	Resistance Whichever is smaller				
Voltage       mechanical breakdown         Temperature       X7R         Characteristics       (From-55 ℃ to 125 ℃, Capacitance change should be within ±15%)         Adhesive Strength of Termination       No peeling shall be occur on the terminal electrode       500g·f, for 10±1 sec.         Bending Strength       Capacitance change : within ±12.5%       Bending to the limit (1mm) with 1.0mm/sec.	Appearance	No abnormal exterior appearance	Microscope (×10)		
Temperature       X7R         Characteristics       (From-55℃ to 125℃, Capacitance change should be within ±15%)         Adhesive Strength of Termination       No peeling shall be occur on the terminal electrode       500g·f, for 10±1 sec.         Bending Strength       Capacitance change : within ±12.5%       Bending to the limit (1mm) with 1.0mm/sec.	Withstanding No dielectric breakdown or		250% of the rated voltage		
Characteristics       (From-55℃ to 125℃, Capacitance change should be within ±15%)         Adhesive Strength of Termination       No peeling shall be occur on the terminal electrode       500g·f, for 10±1 sec.         Bending Strength       Capacitance change : within ±12.5%       Bending to the limit (1mm) with 1.0mm/sec.	√oltage	mechanical breakdown			
Adhesive Strength of Termination Bending Strength Capacitance change: within ±12.5%  Who peeling shall be occur on the terminal electrode  Strength Capacitance change: within ±12.5%  Bending to the limit (1mm) with 1.0mm/sec.	Геmperature	X7R			
of Termination     terminal electrode       Bending Strength     Capacitance change : within ±12.5%     Bending to the limit (1mm) with 1.0mm/sec.	Characteristics	(From-55℃ to 125℃, Capacitance change s	should be within ±15%)		
Bending Strength Capacitance change: within ±12.5% Bending to the limit (1mm) with 1.0mm/sec.	Adhesive Strength	No peeling shall be occur on the			
with 1.0mm/sec.	of Termination	terminal electrode			
	Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)		
Solderability More than 75% of terminal surface SnAg3.0Cu0.5 solder			with 1.0mm/sec.		
	Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder		
is to be soldered newly 245±5°C, 3±0.3sec.		is to be soldered newly	245±5°C, 3±0.3sec.		
(preheating : 80~120°C for 10~30sec.)			(preheating : 80~120°C for 10~30sec.)		
Resistance to Capacitance change: within ±7.5% Solder pot: 270±5℃, 10±1sec.	Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.		
Soldering Heat Tan δ, IR : initial spec.	Soldering Heat	Tan δ, IR : initial spec.			
Vibration TestCapacitance change : within ± 5%Amplitude : 1.5mmTan δ, IR : initial spec.From 10Hz to 55Hz (return : 1min.)2hours × 3 direction (x, y, z)	/ibration Test	, · · · · · · · · · · · · · · · · · · ·	From 10Hz to 55Hz (return : 1min.)		
Moisture Capacitance change: within ±12.5% With rated voltage	Moisture	Capacitance change: within ±12.5%	With rated voltage		
Resistance       Tan δ :       0.05 max       40±2℃, 90~95%RH, 500+12/-0hrs	Resistance	Tan δ : 0.05 max	40±2°C, 90~95%RH, 500+12/-0hrs		
IR : 500Mohm or 25Mohm × <i>μ</i> F					
Whichever is smaller		Whichever is smaller			
High Temperature Capacitance change: within ±12.5% With 200% of the rated voltage	High Temperature	Capacitance change : within ±12.5%	With 200% of the rated voltage		
Resistance    Tan δ :    0.05 max    Max. operating temperature	Resistance		1		
IR : 1,000Mohm or 50Mohm × <i>μ</i> F 1,000+48/-0hrs Whichever is smaller			1,000+48/-0hrs		
Temperature Capacitance change: within ±7.5% 1 cycle condition			1 cycle condition		
Cycling Tan $\delta$ , IR: initial spec. Min. operating temperature $\rightarrow$ 25°C	-		The state of the s		
→ Max. operating temperature → 25°C					
		i e			
5 cycle test					

### D. Recommended Soldering method:

Reflow ( Reflow Peak Temperature : 260±5°C, 30sec. )



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

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The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

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We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

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- ① Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- 4 Military equipment
- ⑤ Disaster prevention/crime prevention equipment
- 6 Power plant control equipment
- Atomic energy-related equipment
- Undersea equipment
- Traffic signal equipment
- Data-processing equipment
- ## Electric heating apparatus, burning equipment
- Safety equipment
- ® Any other applications with the same as or similar complexity or reliability to the applications